

Power MOSFET, 38 A



SOT-227

FEATURES

- Fully isolated package
- Easy to use and parallel
- Low on-resistance
- Dynamic dV/dt rating
- Fully avalanche rated
- Simple drive requirements
- Low drain to case capacitance
- Low internal inductance
- UL approved file E78996 
- Designed for industrial level
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

PRODUCT SUMMARY	
V_{DSS}	500 V
$R_{DS(on)}$	0.13 Ω
I_D	38 A
Type	Modules - MOSFET
Package	SOT-227

DESCRIPTION

Third Generation Power MOSFETs from Vishay HPP provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-227 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 500 W. The low thermal resistance of the SOT-227 contribute to its wide acceptance throughout the industry.

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Continuous drain current at V_{GS} 10 V	I_D	$T_C = 25^\circ\text{C}$	38	A
Pulsed drain current		$T_C = 100^\circ\text{C}$	24	
Pulsed drain current	I_{DM} ⁽¹⁾		150	
Power dissipation	P_D	$T_C = 25^\circ\text{C}$	500	W
Linear derating factor			4.0	W/ $^\circ\text{C}$
Gate to source voltage	V_{GS}		± 20	V
Single pulse avalanche energy	E_{AS} ⁽²⁾		580	mJ
Avalanche current	I_{AR} ⁽¹⁾		38	A
Repetitive avalanche energy	E_{AR} ⁽¹⁾		50	mJ
Peak diode recovery dV/dt	dV/dt ⁽³⁾		10	V/ns
Operating junction and storage temperature range	T_J, T_{Stg}		- 55 to + 150	$^\circ\text{C}$
Insulation withstand voltage (AC-RMS)	V_{ISO}		2.5	kV
Mounting torque		M4 screw	1.3	Nm

Notes

(1) Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

(2) Starting $T_J = 25^\circ\text{C}$, $L = 0.80$ mH, $R_g = 25 \Omega$, $I_{AS} = 38$ A (see fig. 12)

(3) $I_{SD} \leq 38$ A, $dI/dt \leq 410$ A/ μs , $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150^\circ\text{C}$

THERMAL RESISTANCE				
PARAMETER	SYMBOL	TYP.	MAX.	UNITS
Junction to case	R_{thJC}	-	0.25	
Case to sink, flat, greased surface	R_{thCS}	0.05	-	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain to source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0$ V, $I_D = 1.0$ mA	500	-	-	V
Breakdown voltage temperature coefficient	$\Delta V_{(BR)DSS}/\Delta T_J$	Reference to 25 °C, $I_D = 1$ mA	-	0.66	-	°V/°C
Static drain to source on-resistance	$R_{DS(on)}$ (1)	$V_{GS} = 10$ V, $I_D = 23$ A	-	-	0.13	Ω
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250$ μA	2.0	-	4.0	V
Forward transconductance	g_{fs}	$V_{DS} = 25$ V, $I_D = 23$ A	22	-	-	S
Drain to source leakage current	I_{DSS}	$V_{DS} = 500$ V, $V_{GS} = 0$ V	-	-	50	μA
		$V_{DS} = 400$ V, $V_{GS} = 0$ V, $T_J = 125$ °C	-	-	500	
Gate to source forward leakage	I_{GSS}	$V_{GS} = 20$ V	-	-	200	nA
Gate to source reverse leakage		$V_{GS} = -20$ V	-	-	-200	
Total gate charge	Q_g	$I_D = 38$ A	-	280	420	nC
Gate to source charge	Q_{gs}	$V_{DS} = 400$ V	-	37	55	
Gate to drain ("Miller") charge	Q_{gd}	$V_{GS} = 10$ V; see fig. 6 and 13 (1)	-	150	220	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 250$ V	-	42	-	ns
Rise time	t_r	$I_D = 38$ A	-	340	-	
Turn-off delay time	$t_{d(off)}$	$R_g = 10 \Omega$ (ιντερναλ)	-	200	-	
Fall time	t_f	$R_D = 8 \Omega$, see fig. 10 (1)	-	330	-	
Internal source inductance	L_s	Between lead, and center of die contact	-	5.0	-	nH
Input capacitance	C_{iss}	$V_{GS} = 0$ V	-	6900	-	pF
Output capacitance	C_{oss}	$V_{DS} = 25$ V	-	1600	-	
Reverse transfer capacitance	C_{rss}	$f = 1.0$ MHz, see fig. 5	-	580	-	

Note

(1) Pulse width ≤ 300 μs, duty cycle ≤ 2 %

SOURCE-DRAIN RATINGS AND CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Continuous source current (body diode)	I_s	MOSFET symbol showing the integral reverse p-n junction diode.	-	-	38	A
Pulsed source current (body diode)	I_{SM} (1)		-	-	150	
Diode forward voltage	V_{SD} (2)	$T_J = 25$ °C, $I_s = 38$ A, $V_{GS} = 0$ V	-	-	1.3	V
Reverse recovery time	t_{rr}	$T_J = 25$ °C, $I_F = 38$ A; $dl/dt = 100$ A/μs (2)	-	830	1300	ns
Reverse recovery charge	Q_{rr}		-	15	22	μC
Forward turn-on time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by $L_s + L_D$)				

Notes

(1) Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

(2) Pulse width ≤ 300 μs, duty cycle ≤ 2 %

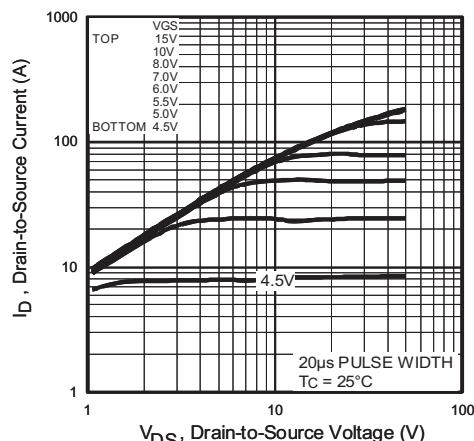


Fig. 1 - Typical Output Characteristics

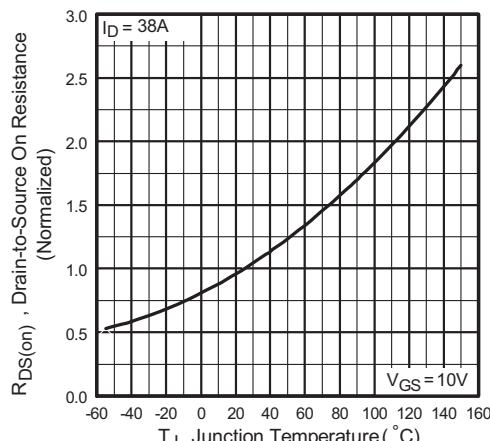


Fig. 4 - Normalized On-Resistance vs. Temperature

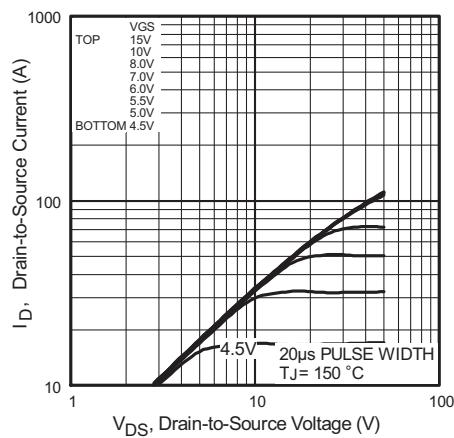


Fig. 2 - Typical Output Characteristics

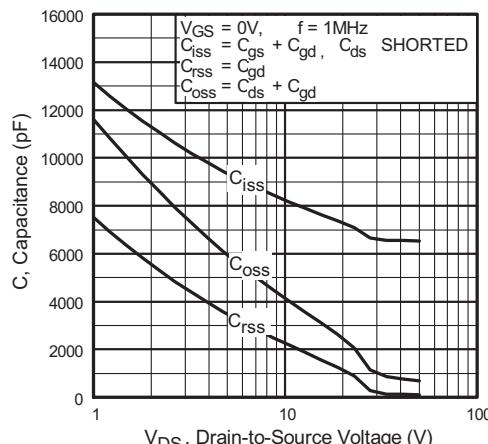


Fig. 5 - Typical Capacitance vs.
Drain to Source Voltage

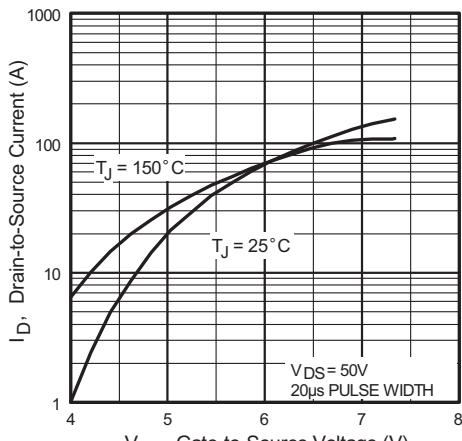


Fig. 3 - Typical Transfer Characteristics

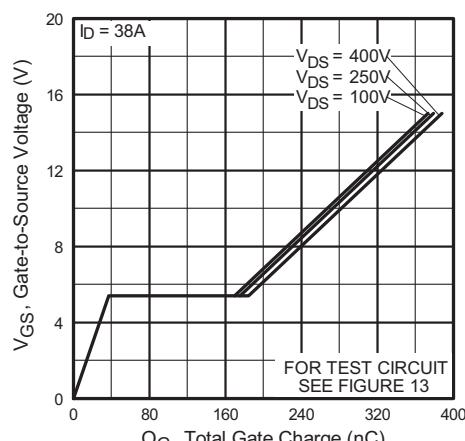


Fig. 6 - Typical Gate Charge vs.
Gate to Source Voltage

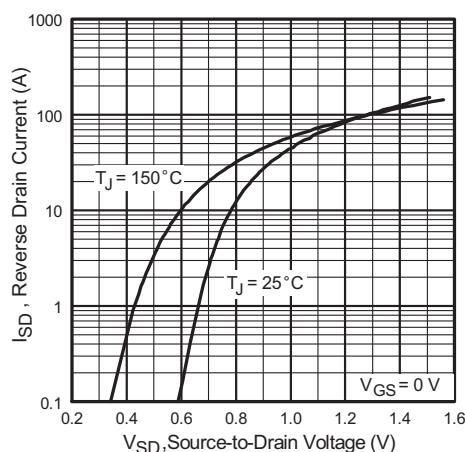


Fig. 7 - Typical Source Drain Diode Forward Voltage

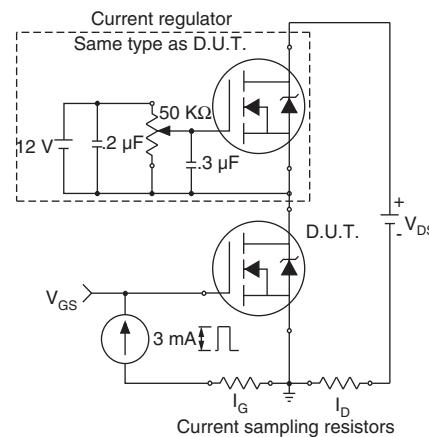


Fig. 10 - Gate Charge Test Circuit

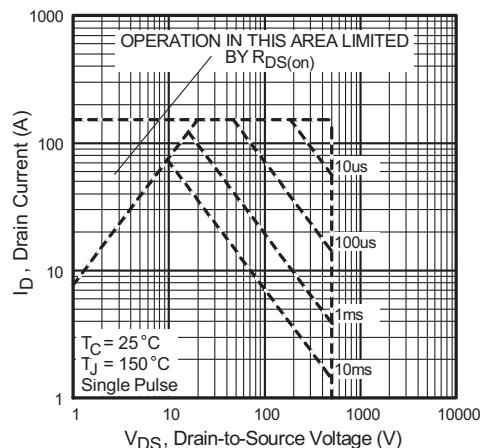


Fig. 8 - Maximum Safe Operating Area

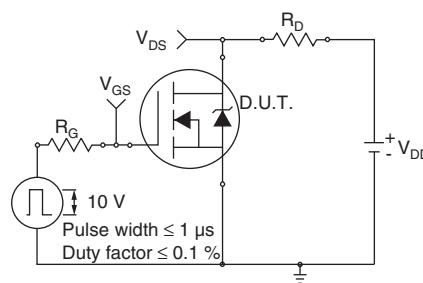


Fig. 11 - Switching Time Test Circuit

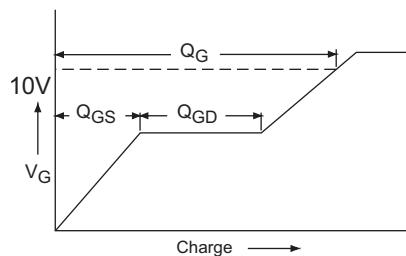


Fig. 9 - Basic Gate Charge Waveform

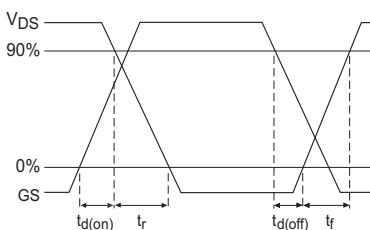


Fig. 12 - Switching Time Waveforms

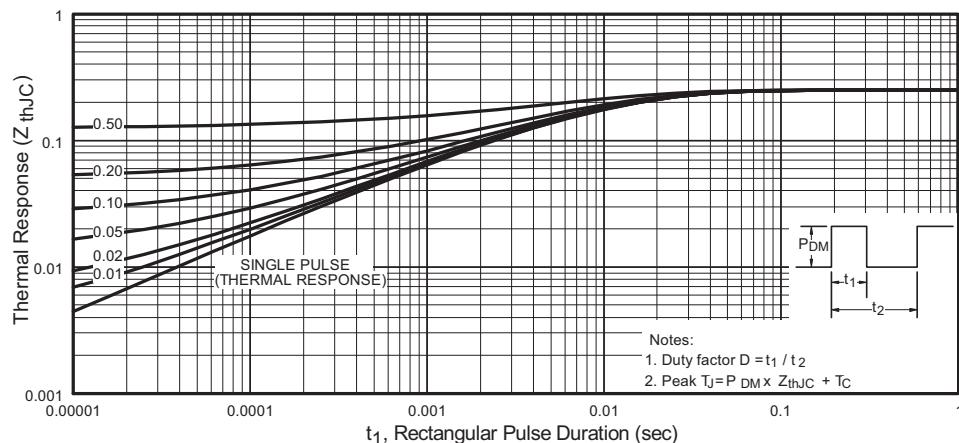


Fig. 13 - Maximum Effective Transient Thermal Impedance, Junction to Case

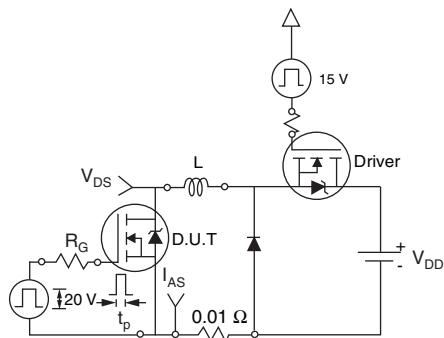


Fig. 14 - Unclamped Inductive Test Circuit

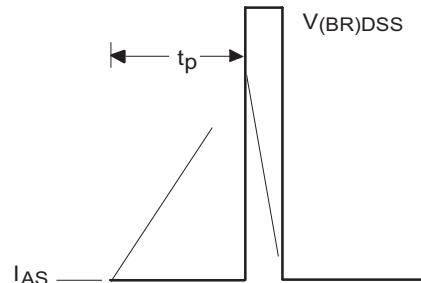


Fig. 15 - Unclamped Inductive Waveforms

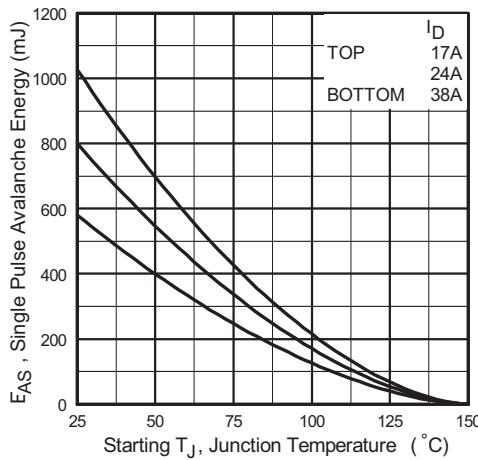


Fig. 16 - Maximum Avalanche Energy vs. Drain Current

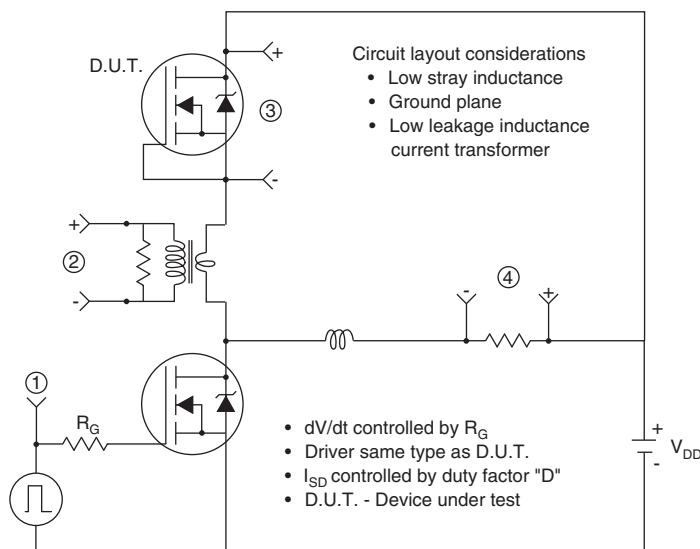
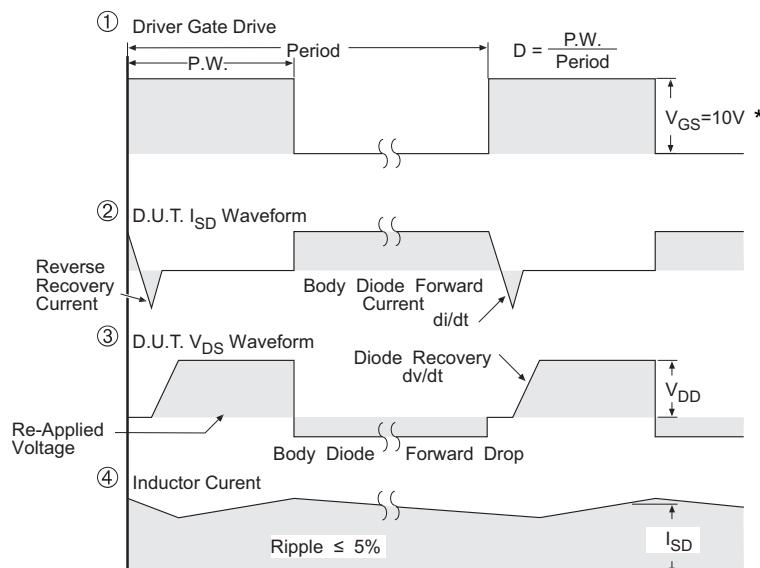


Fig. 17 - Peak Diode Recovery dV/dt Test Circuit

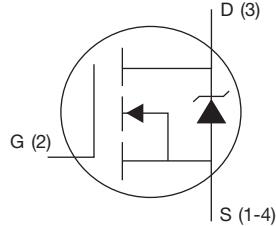
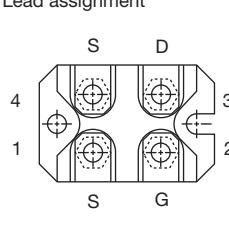


* $V_{GS} = 5V$ for Logic Level Devices

Fig. 18 - For N-Channel Power MOSFETs

ORDERING INFORMATION TABLE

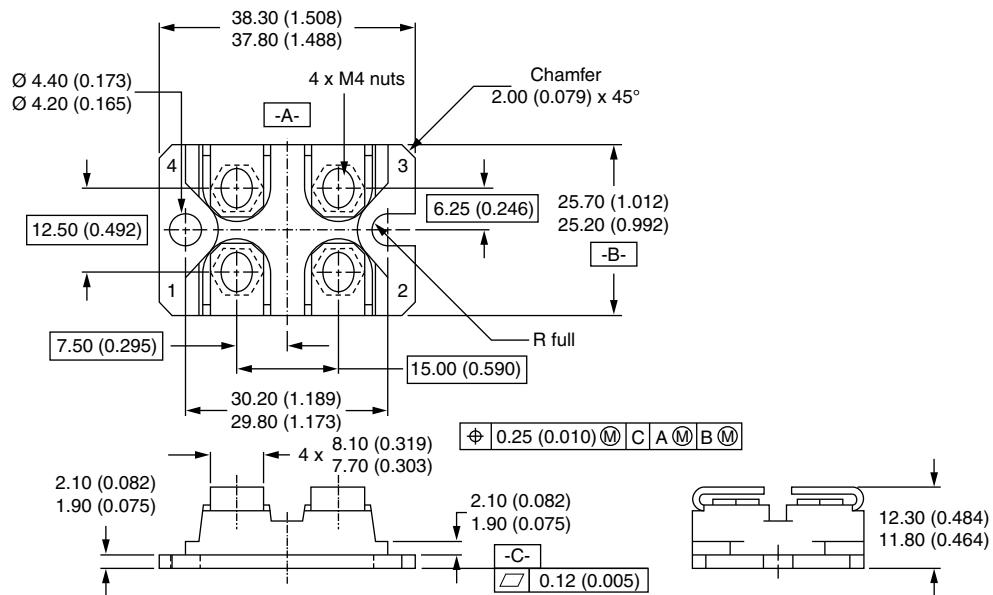
Device code	F	A	38	S	A	50	LC	P
	1	2	3	4	5	6	7	8
1	-	Power MOSFET						
2	-	Generation 3, MOSFET silicon, DBC construction						
3	-	Current rating (38 = 38 A)						
4	-	Single switch (see Circuit Configuration table)						
5	-	SOT-227						
6	-	Voltage rating (50 = 500 V)						
7	-	Low charge						
8	-	P = Lead (Pb)-free						

CIRCUIT CONFIGURATION		
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
Single switch no diode	S	 Lead assignment 

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95036
Packaging information	www.vishay.com/doc?95037

SOT-227

DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
 - Controlling dimension: millimeter

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